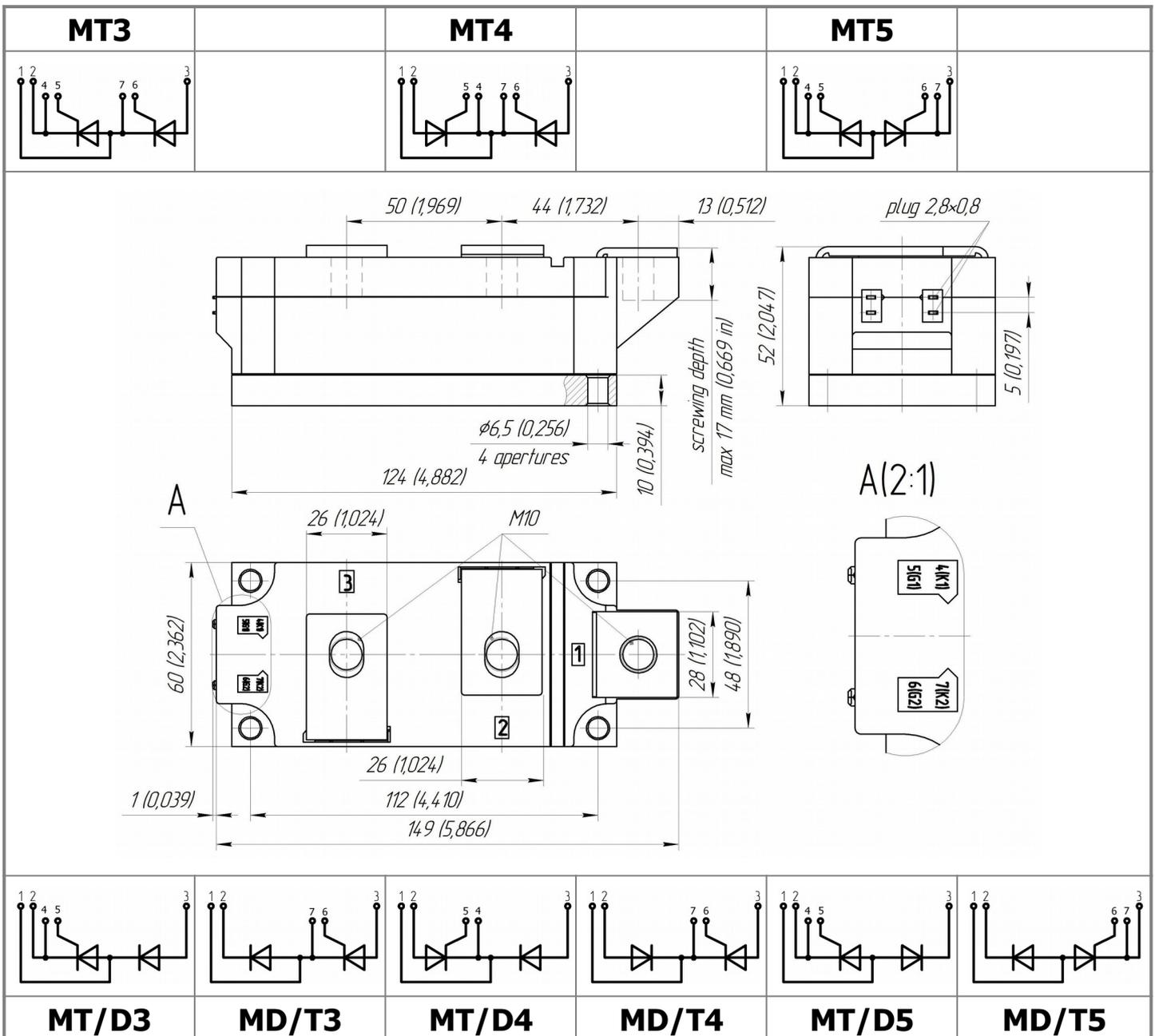




Electrically isolated base plate
 Industrial standard package
 Simplified mechanical design, rapid assembly
 Pressure contact

**Double Thyristor Module
 For Phase Control
 MTx-430-24-A2**

Mean on-state current	I_{TAV}	430 A	
Repetitive peak off-state voltage	V_{DRM}	2000 ÷ 2400 V	
Repetitive peak reverse voltage	V_{RRM}		
Turn-off time	t_q	250 μ s	
V_{DRM}, V_{RRM}, V	2000	2200	2400
Voltage code	20	22	24
$T_j, ^\circ C$	- 40 ÷ 125		



All dimensions in millimeters (inches)

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters		Units	Values	Test conditions
ON-STATE				
I_{TAV}	Mean on-state current	A	430	$T_c=85\text{ }^\circ\text{C}$; 180° half-sine wave; 50 Hz
I_{TRMS}	RMS on-state current	A	675	
I_{TSM}	Surge on-state current	kA	12.0 14.0	$T_j=T_{j\max}$ $T_j=25\text{ }^\circ\text{C}$ 180° half-sine wave; $t_p=10\text{ ms}$; single pulse; $V_D=V_R=0\text{ V}$; Gate pulse: $I_G=2\text{ A}$; $t_{GP}=50\text{ }\mu\text{s}$; $di_G/dt\geq 1\text{ A}/\mu\text{s}$
			13.0 15.0	$T_j=T_{j\max}$ $T_j=25\text{ }^\circ\text{C}$ 180° half-sine wave; $t_p=8.3\text{ ms}$; single pulse; $V_D=V_R=0\text{ V}$; Gate pulse: $I_G=2\text{ A}$; $t_{GP}=50\text{ }\mu\text{s}$; $di_G/dt\geq 1\text{ A}/\mu\text{s}$
I^2t	Safety factor	$A^2s\cdot 10^3$	720 980	$T_j=T_{j\max}$ $T_j=25\text{ }^\circ\text{C}$ 180° half-sine wave; $t_p=10\text{ ms}$; single pulse; $V_D=V_R=0\text{ V}$; Gate pulse: $I_G=2\text{ A}$; $t_{GP}=50\text{ }\mu\text{s}$; $di_G/dt\geq 1\text{ A}/\mu\text{s}$
			700 930	$T_j=T_{j\max}$ $T_j=25\text{ }^\circ\text{C}$ 180° half-sine wave; $t_p=8.3\text{ ms}$; single pulse; $V_D=V_R=0\text{ V}$; Gate pulse: $I_G=2\text{ A}$; $t_{GP}=50\text{ }\mu\text{s}$; $di_G/dt\geq 1\text{ A}/\mu\text{s}$
BLOCKING				
V_{DRM}, V_{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	2000÷2400	$T_{j\min} < T_j < T_{j\max}$; 180° half-sine wave; 50 Hz; Gate open
V_{DSM}, V_{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	2100÷2500	$T_{j\min} < T_j < T_{j\max}$; 180° half-sine wave; single pulse; Gate open
V_D, V_R	Direct off-state and Direct reverse voltages	V	$0.6\cdot V_{DRM}$ $0.6\cdot V_{RRM}$	$T_j=T_{j\max}$; Gate open
TRIGGERING				
I_{FGM}	Peak forward gate current	A	8	$T_j=T_{j\max}$
V_{RGM}	Peak reverse gate voltage	V	5	
P_G	Gate power dissipation	W	4	$T_j=T_{j\max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ($f=1\text{ Hz}$)	$A/\mu\text{s}$	400	$T_j=T_{j\max}$; $V_D=0.67\cdot V_{DRM}$; $I_{TM}=2\text{ }I_{TAV}$; Gate pulse: $I_G=2\text{ A}$; $t_{GP}=50\text{ }\mu\text{s}$; $di_G/dt\geq 2\text{ A}/\mu\text{s}$
THERMAL				
T_{stg}	Storage temperature	$^\circ\text{C}$	-40 ÷ 50	
T_j	Operating junction temperature	$^\circ\text{C}$	-40 ÷ 125	
MECHANICAL				
a	Acceleration under vibration	m/s^2	50	

CHARACTERISTICS

Symbols and parameters		Units	Values	Conditions	
ON-STATE					
V_{TM}	Peak on-state voltage, max	V	1.55	$T_j=25\text{ °C}; I_{TM}=1256\text{A}$	
$V_{T(TO)}$	On-state threshold voltage, max	V	1.00	$T_j=T_{j\text{ max}};$	
r_T	On-state slope resistance, max	mΩ	0.410	$0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$	
I_L	Latching current, max	mA	1000	$T_j=25\text{ °C}; V_D=12\text{ V};$ Gate pulse: $I_G=2\text{ A};$ $t_{GP}=50\text{ }\mu\text{s}; di_G/dt \geq 1\text{ A}/\mu\text{s}$	
I_H	Holding current, max	mA	300	$T_j=25\text{ °C};$ $V_D=12\text{ V};$ Gate open	
BLOCKING					
I_{DRM}, I_{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	100	$T_j=T_{j\text{ max}};$ $V_D=V_{DRM}; V_R=V_{RRM}$	
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage ¹⁾ , min	V/ μs	1000	$T_j=T_{j\text{ max}};$ $V_D=0.67 \cdot V_{DRM};$ Gate open	
TRIGGERING					
V_{GT}	Gate trigger direct voltage, max	V	4.00	$T_j = T_{j\text{ min}}$ $T_j=25\text{ °C}$ $T_j = T_{j\text{ max}}$	$V_D=12\text{ V}; I_D=3\text{ A};$ Direct gate current
			2.50		
I_{GT}	Gate trigger direct current, max	mA	400	$T_j = T_{j\text{ min}}$ $T_j = 25\text{ °C}$ $T_j = T_{j\text{ max}}$	
			250		
			200		
V_{GD}	Gate non-trigger direct voltage, min	V	0.25	$T_j=T_{j\text{ max}};$ $V_D=0.67 \cdot V_{DRM};$	
I_{GD}	Gate non-trigger direct current, min	mA	10.00		Direct gate current
SWITCHING					
t_{gd}	Delay time	μs	2.50	$T_j=25\text{ °C}; V_D=1000\text{ V}; I_{TM}=I_{TAV};$ $di/dt=200\text{ A}/\mu\text{s};$ Gate pulse: $I_G=2\text{ A}; V_G=20\text{ V};$ $t_{GP}=50\text{ }\mu\text{s}; di_G/dt=2\text{ A}/\mu\text{s}$	
t_q	Turn-off time ²⁾ , max	μs	250	$dv_D/dt=50\text{ V}/\mu\text{s}; T_j=T_{j\text{ max}}; I_{TM}= I_{TAV};$ $di_R/dt=10\text{ A}/\mu\text{s}; V_R=100\text{V};$ $V_D=0.67 V_{DRM};$	
THERMAL					
R_{thjc}	Thermal resistance, junction to case				
	per module	$^{\circ}\text{C}/\text{W}$	0.0325	180° half-sine wave, 50 Hz	
	per arm	$^{\circ}\text{C}/\text{W}$	0.0650		
	per module	$^{\circ}\text{C}/\text{W}$	0.0310	DC	
per arm	$^{\circ}\text{C}/\text{W}$	0.0620			
R_{thch}	Thermal resistance, case to heatsink				
	per module	$^{\circ}\text{C}/\text{W}$	0.0100		
	per arm	$^{\circ}\text{C}/\text{W}$	0.0200		
INSULATION					
V_{ISOL}	Insulation test voltage	kV	3.00	Sine wave, 50 Hz; RMS	t=1 min
			3.60		t=1 sec
MECHANICAL					
M_1	Mounting torque (M6) ³⁾	Nm	6.00	Tolerance $\pm 15\%$	
M_2	Terminal connection torque (M10) ³⁾	Nm	12.00	Tolerance $\pm 15\%$	
w	Weight	g	1500		

PART NUMBERING GUIDE

MT	3	-	430	-	24	-	A2	M2	-	A2	-	N
1	2		3		4		5	6		7		8

1. Thyristor module (MT)
Thyristor – Diode module (MT/D)
Diode – Thyristor module (MD/T)
2. Circuit Schematic:
3 – serial connection
4 – common Cathode
5 – common Anode
3. Average On-state Current, A
4. Voltage Code
5. Critical rate of rise of off-state voltage
6. Group of turn-off time ($dv_D/dt=50 \text{ V}/\mu\text{s}$)
7. Package Type (M.A2)
8. Ambient Conditions:
N – Normal

NOTES

¹⁾ Critical rate of rise of off-state voltage

Symbol of group	A2
$(dv_D/dt)_{crit}, \text{ V}/\mu\text{s}$	1000

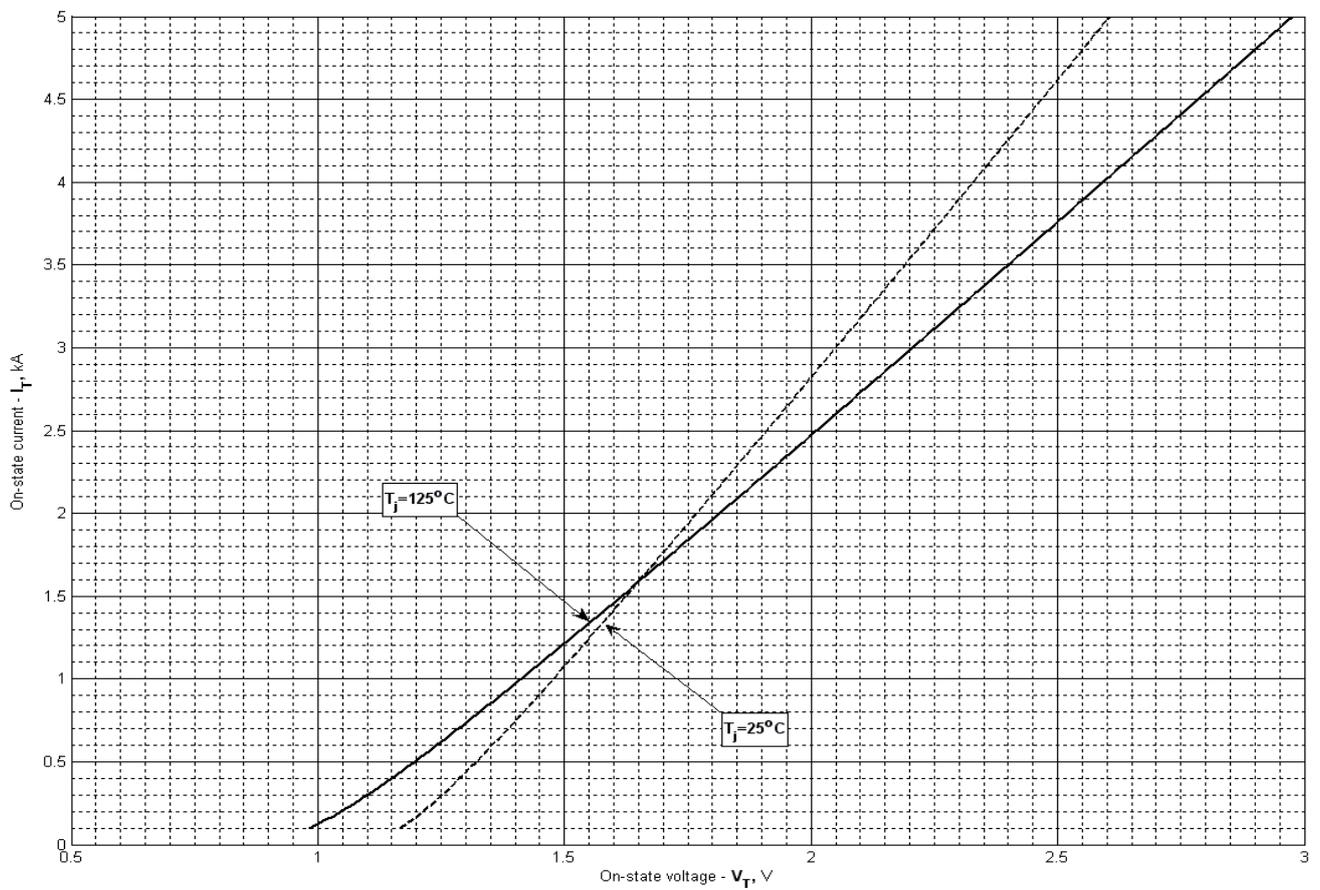
²⁾ Turn-off time ($dv_D/dt=50 \text{ V}/\mu\text{s}$)

Symbol of group	M2
$t_{q}, \mu\text{s}$	250

³⁾ The screws must be lubricated



UL certified file-No. E255404



MTx-430-A, 18-Jan-2008

Fig 1 – On-state characteristics of Limit device

Analytical function for On-state characteristic:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

	Coefficients for max curves	
	$T_j = 25^\circ\text{C}$	$T_j = T_{j\text{max}}$
A	1.069142	0.852344
B	0.239424	0.334163
C	-0.158239	-0.211339
D	0.278291	0.371677

On-state characteristic model (see Fig. 1)

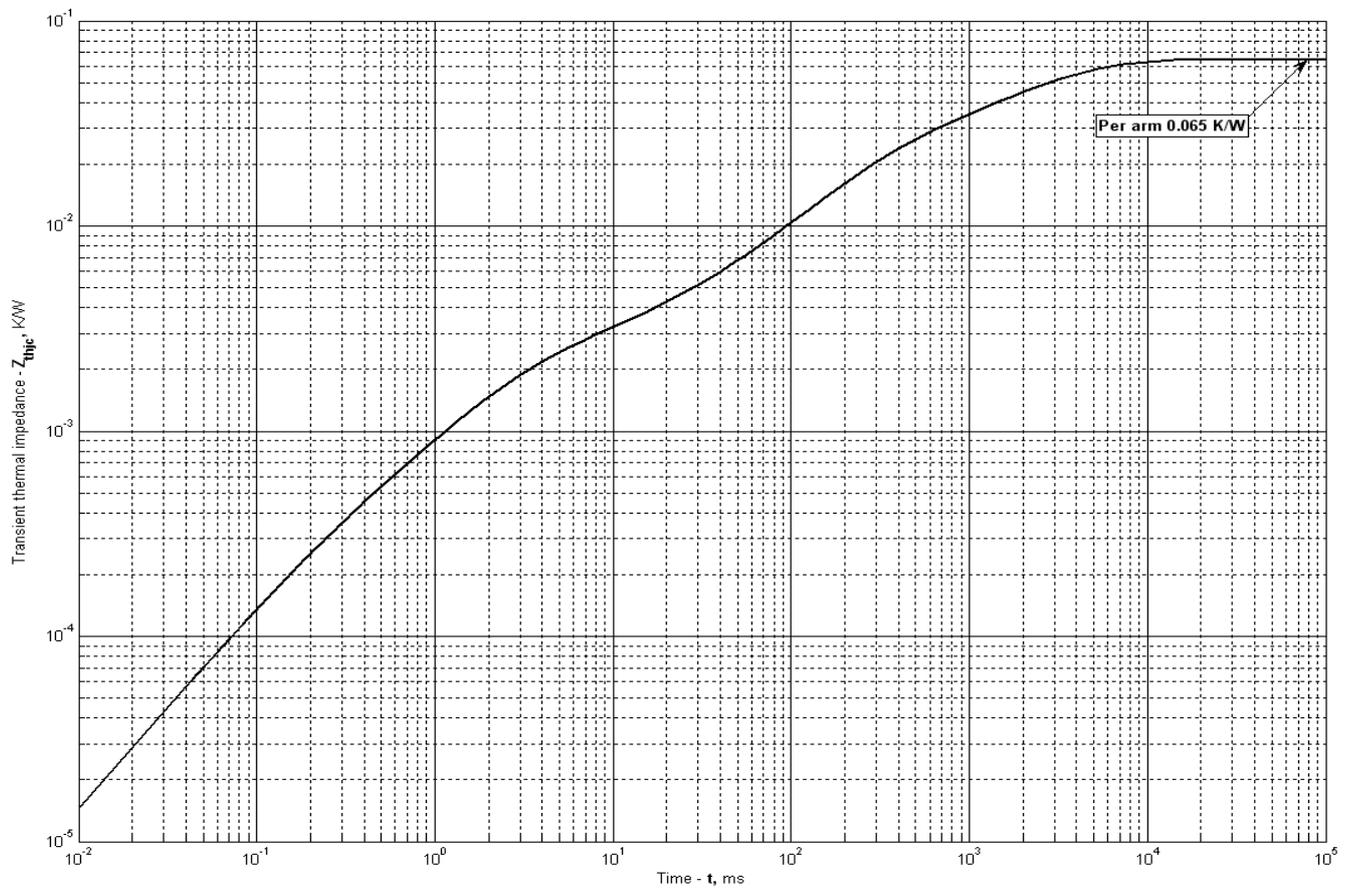


Fig 2 – Transient thermal impedance

Analytical function for Transient thermal impedance junction to case Z_{thjc} for DC:

$$Z_{thjc} = \sum_{i=1}^n R_i \left(1 - e^{-\frac{t}{\tau_i}} \right)$$

Where $i = 1$ to n , n is the number of terms in the series.

t = Duration of heating pulse in seconds.

Z_{thjc} = Thermal resistance at time t .

R_i = Amplitude of p_{th} term.

τ_i = Time constant of r_{th} term.

i	1	2	3	4	5	6
R_i, K/W	0.0344	0.0112	0.01635	0.0006528	0.001791	0.0001363
τ_i, s	3.132	1.000	0.2335	0.01038	0.002348	0.0002448

Transient thermal impedance junction to case Z_{thjc} model (see Fig. 2)

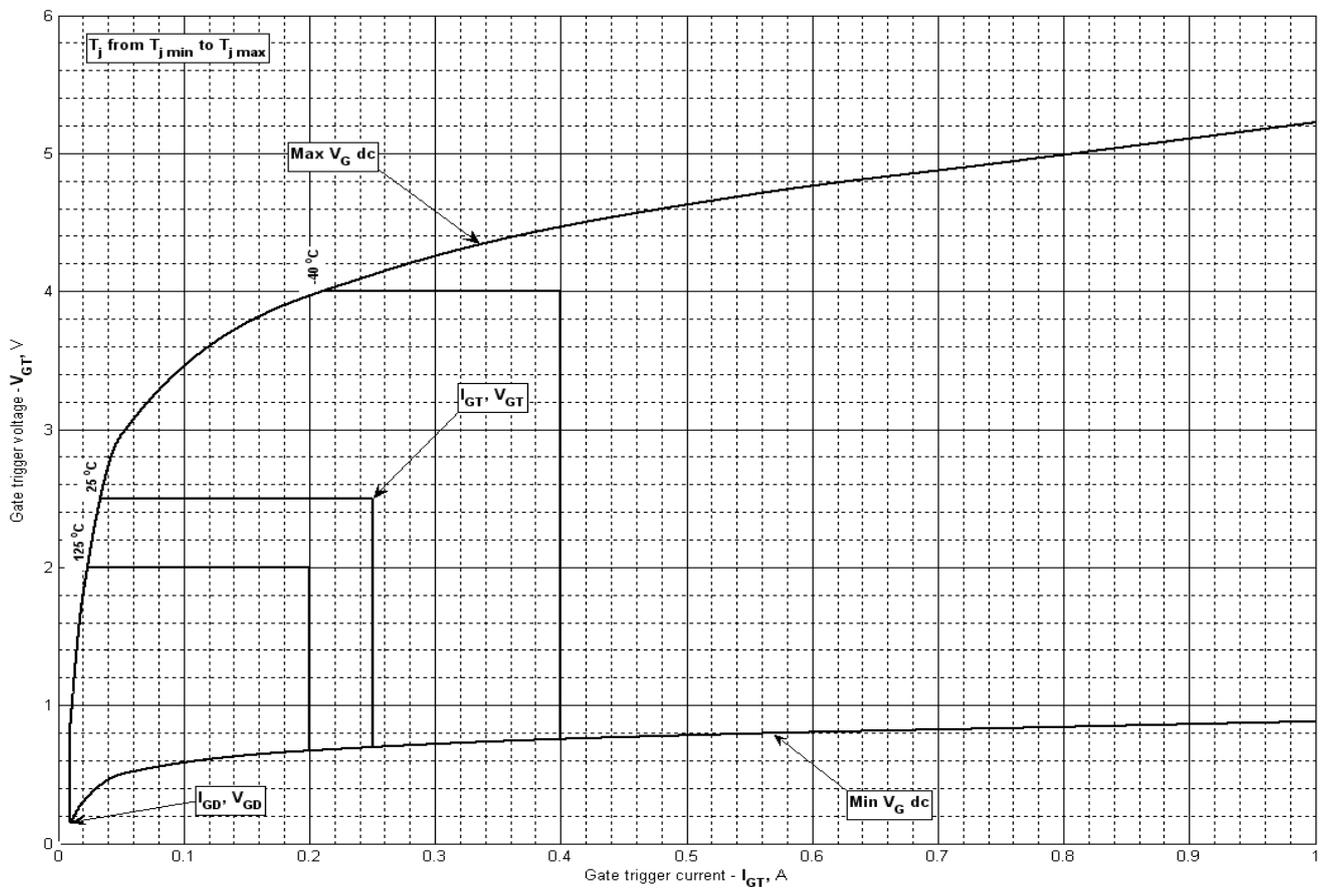


Fig 3 – Gate characteristics – Trigger limits

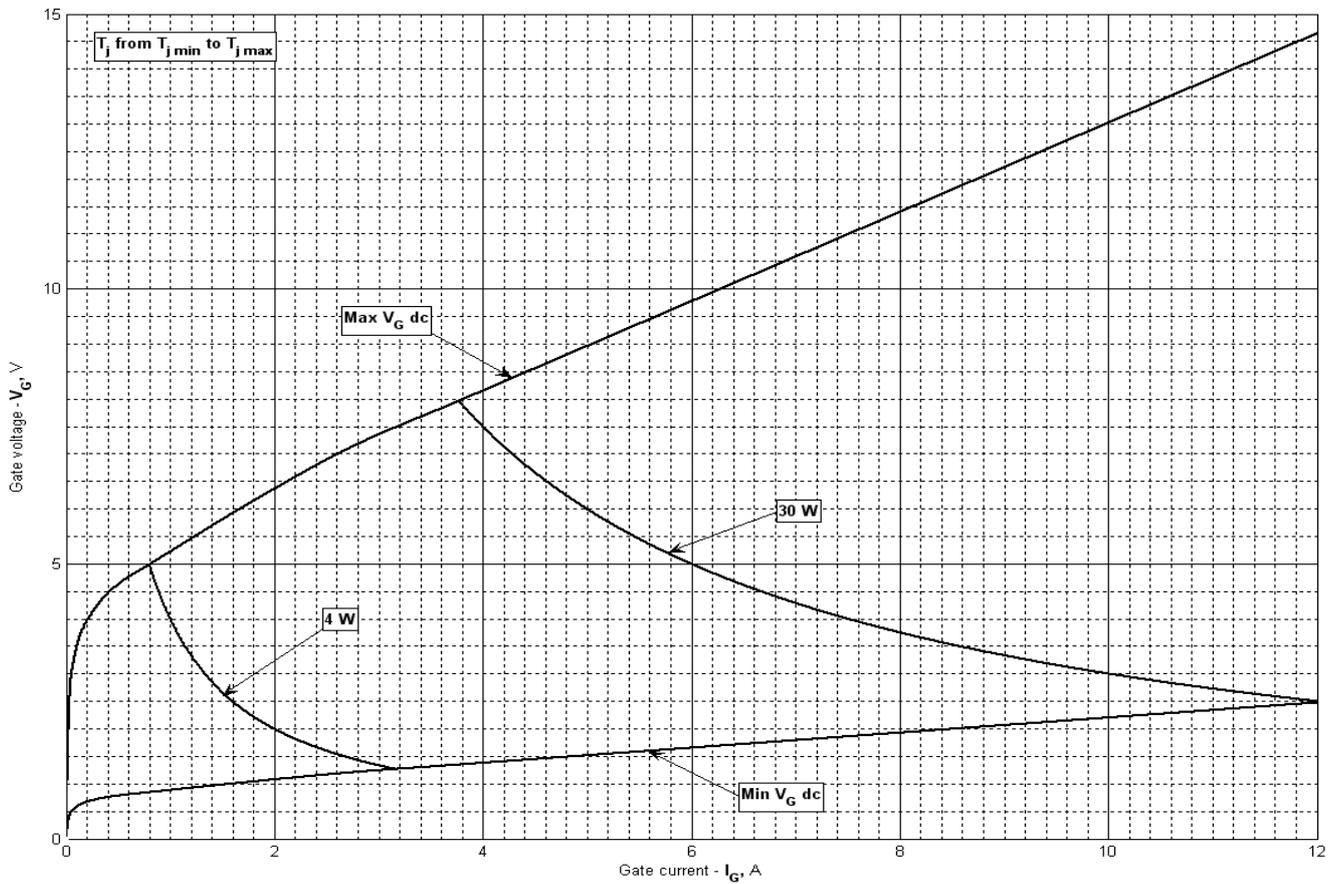


Fig 4 - Gate characteristics – Power curves

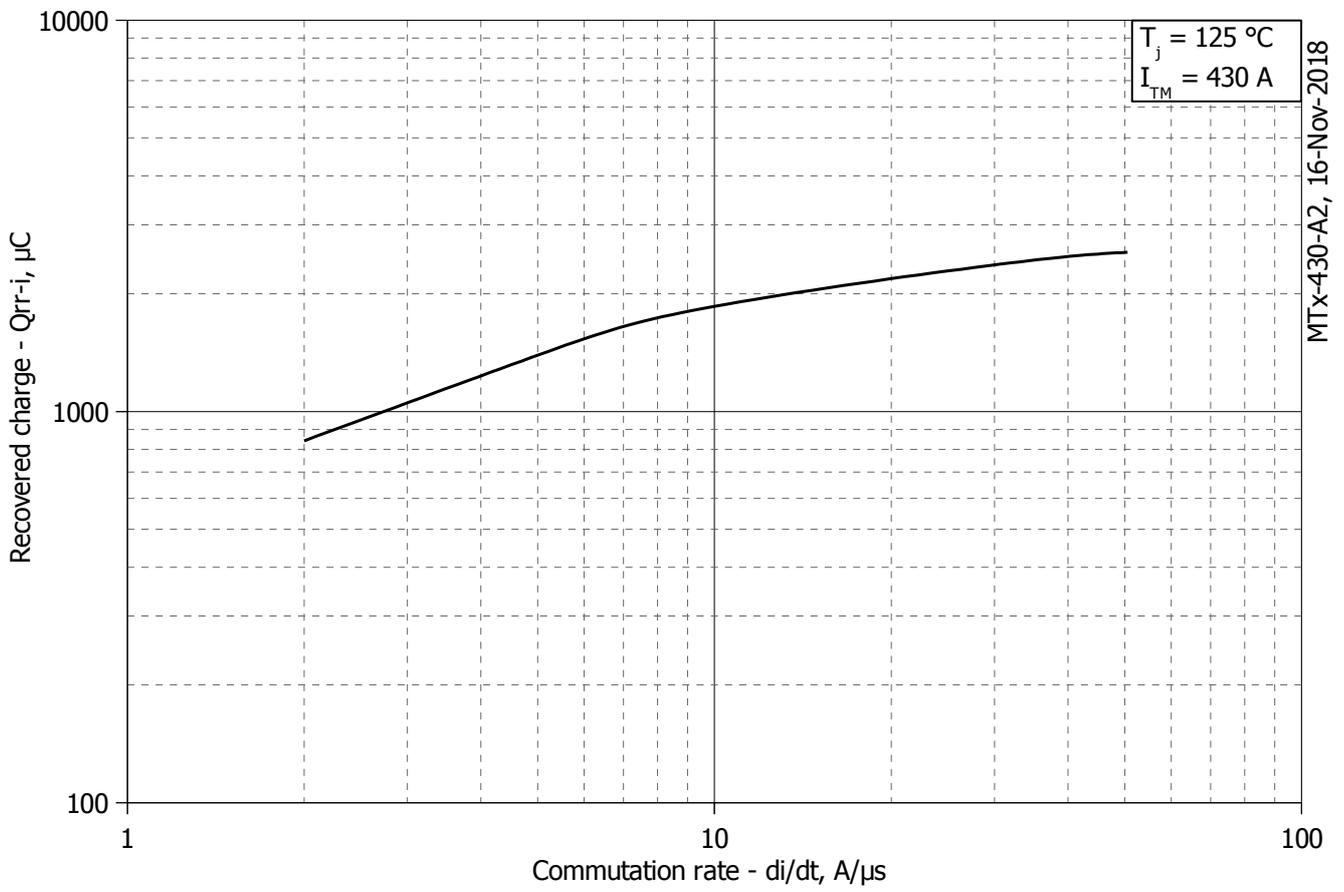


Fig 5 - Total recovered charge, Q_{rr-i} (integral)

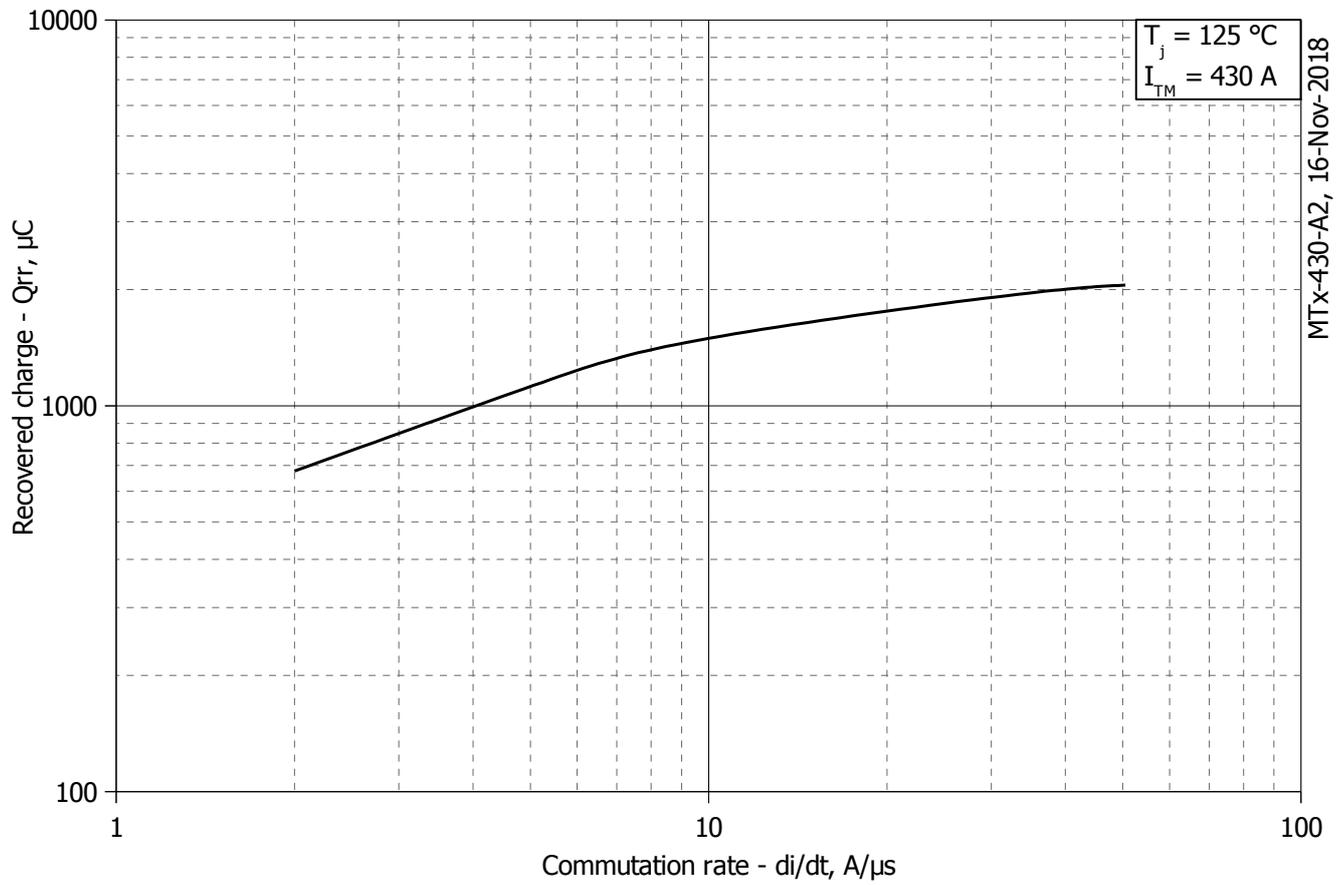


Fig 6 - Recovered charge, Q_{rr} (25% chord)

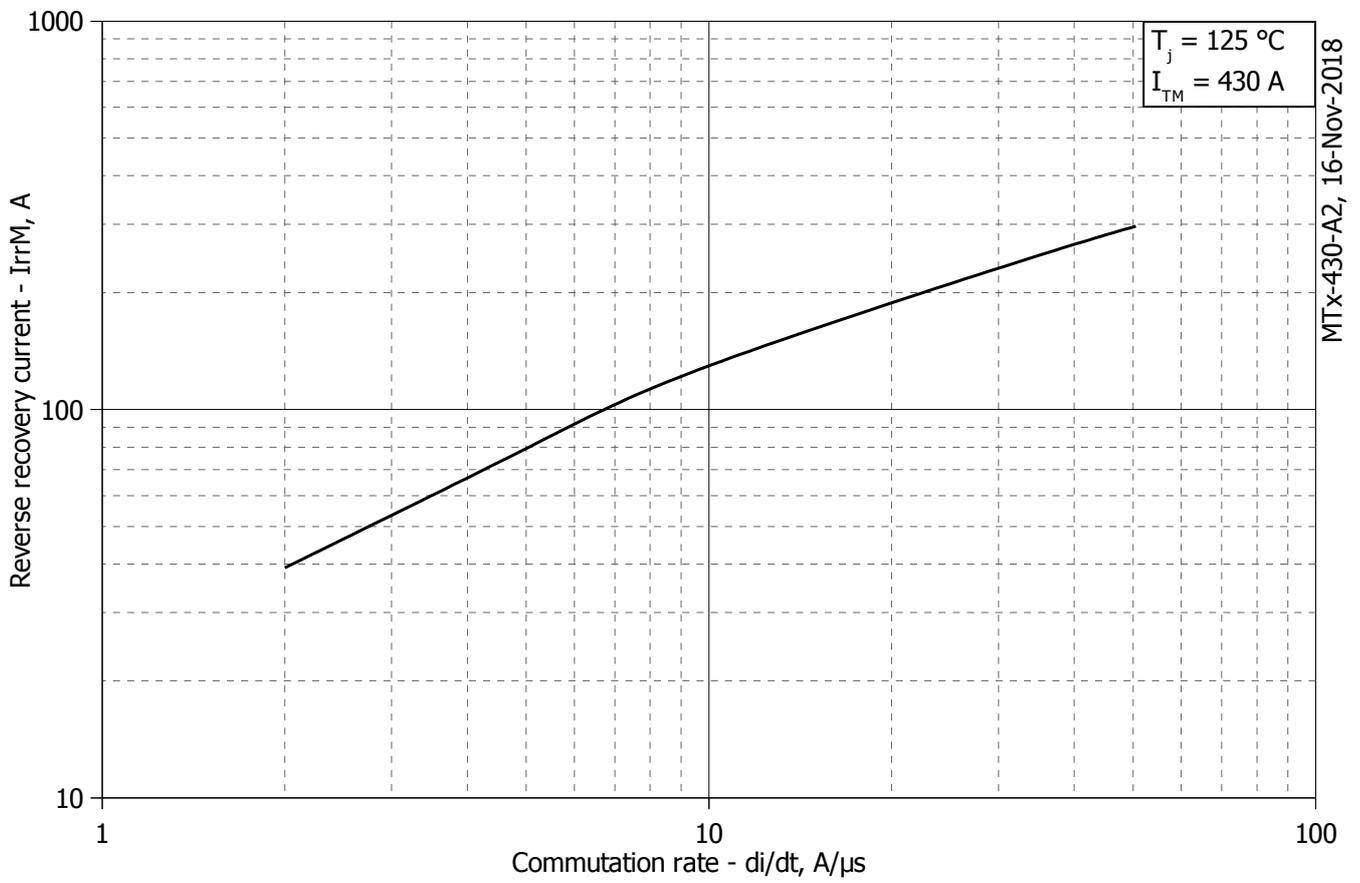


Fig 7 - Peak reverse recovery current, I_{rrM}

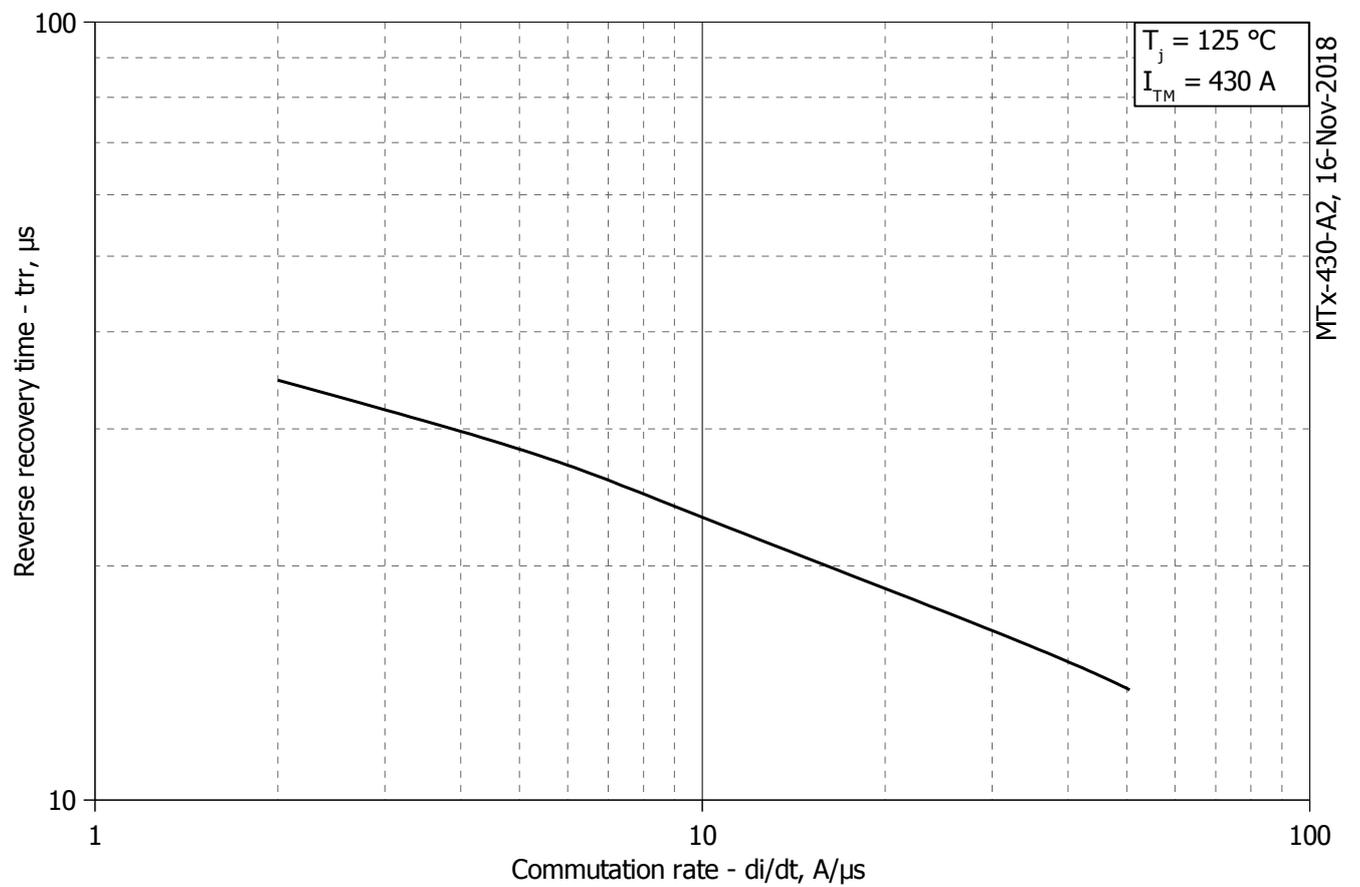


Fig 8 - Maximum recovery time, t_{rr} (25% chord)

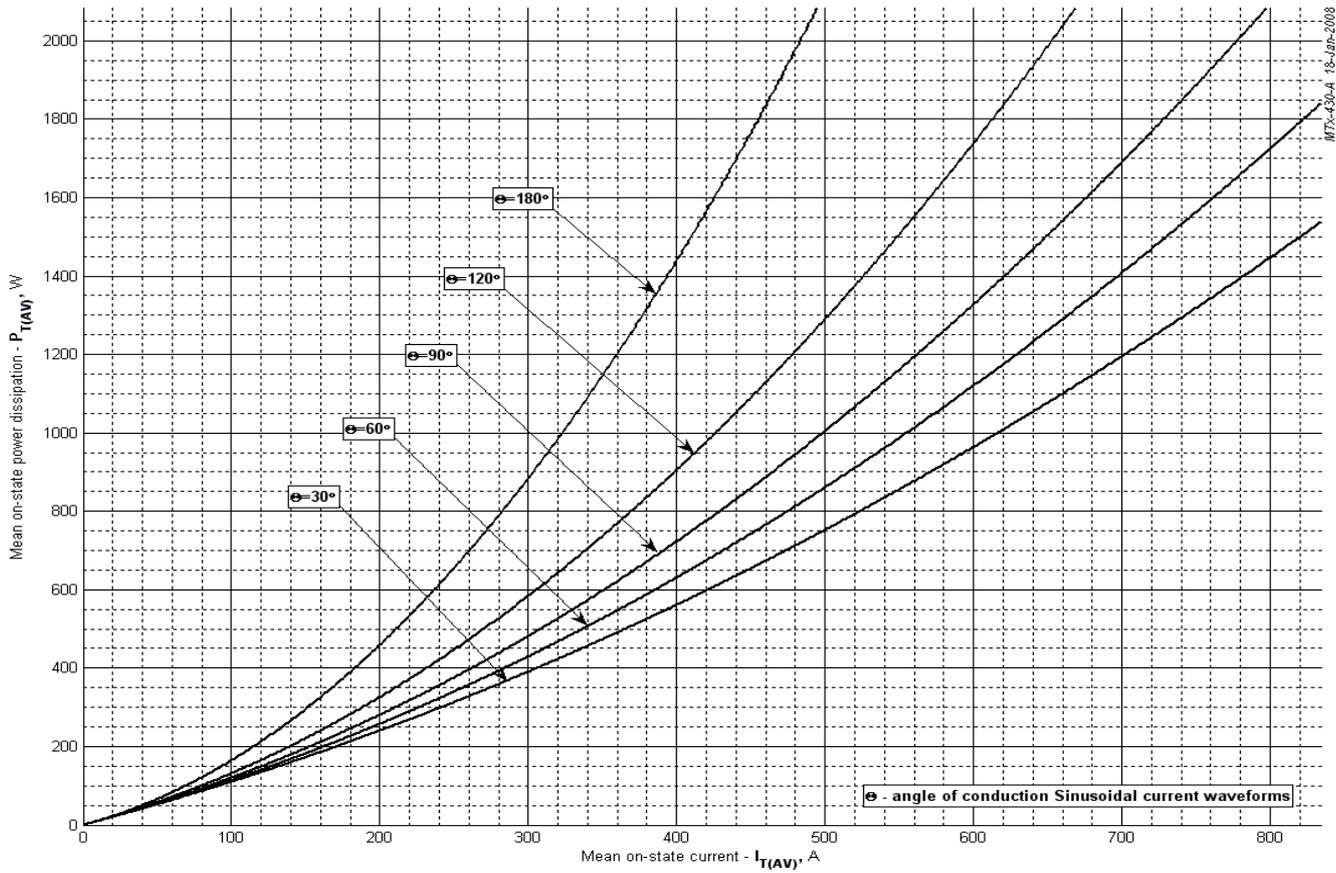


Fig 9 – On-state power loss (sinusoidal current waveforms)

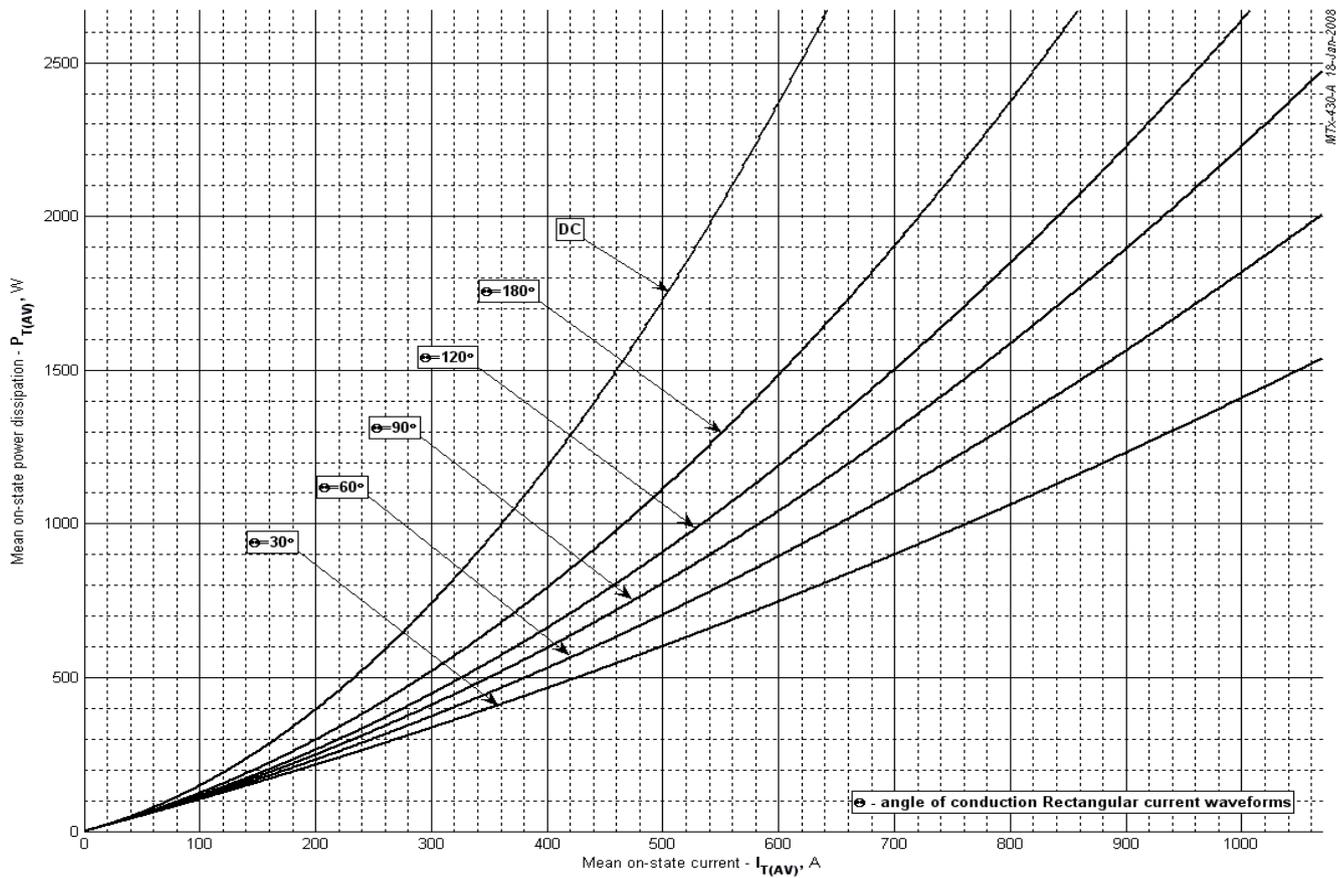


Fig 10 - On-state power loss (rectangular current waveforms)

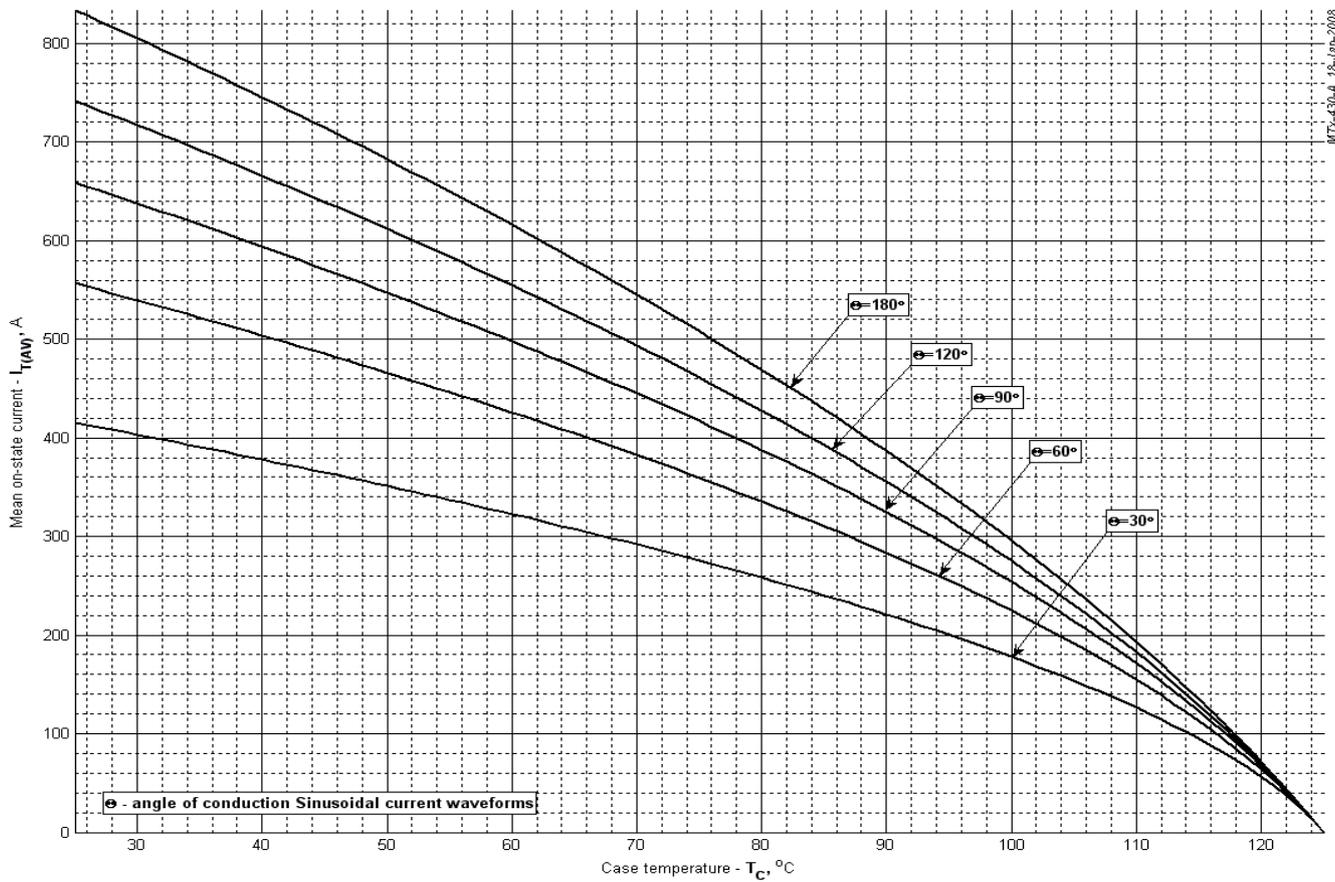


Fig 11 – Maximum case temperature (sinusoidal current waveforms)

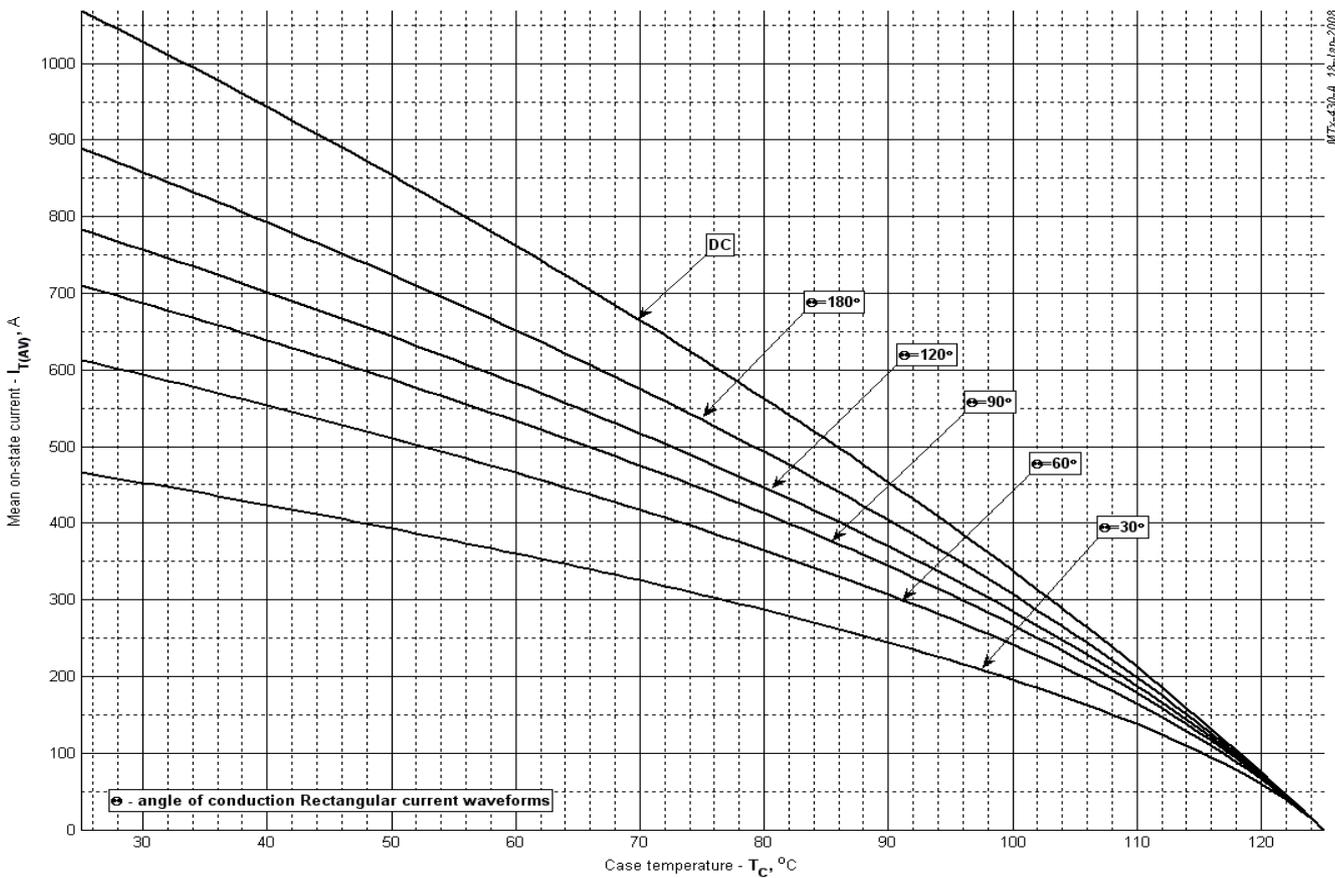


Fig 12 - Maximum case temperature (rectangular current waveforms)

$T_J = 125^\circ\text{C}$

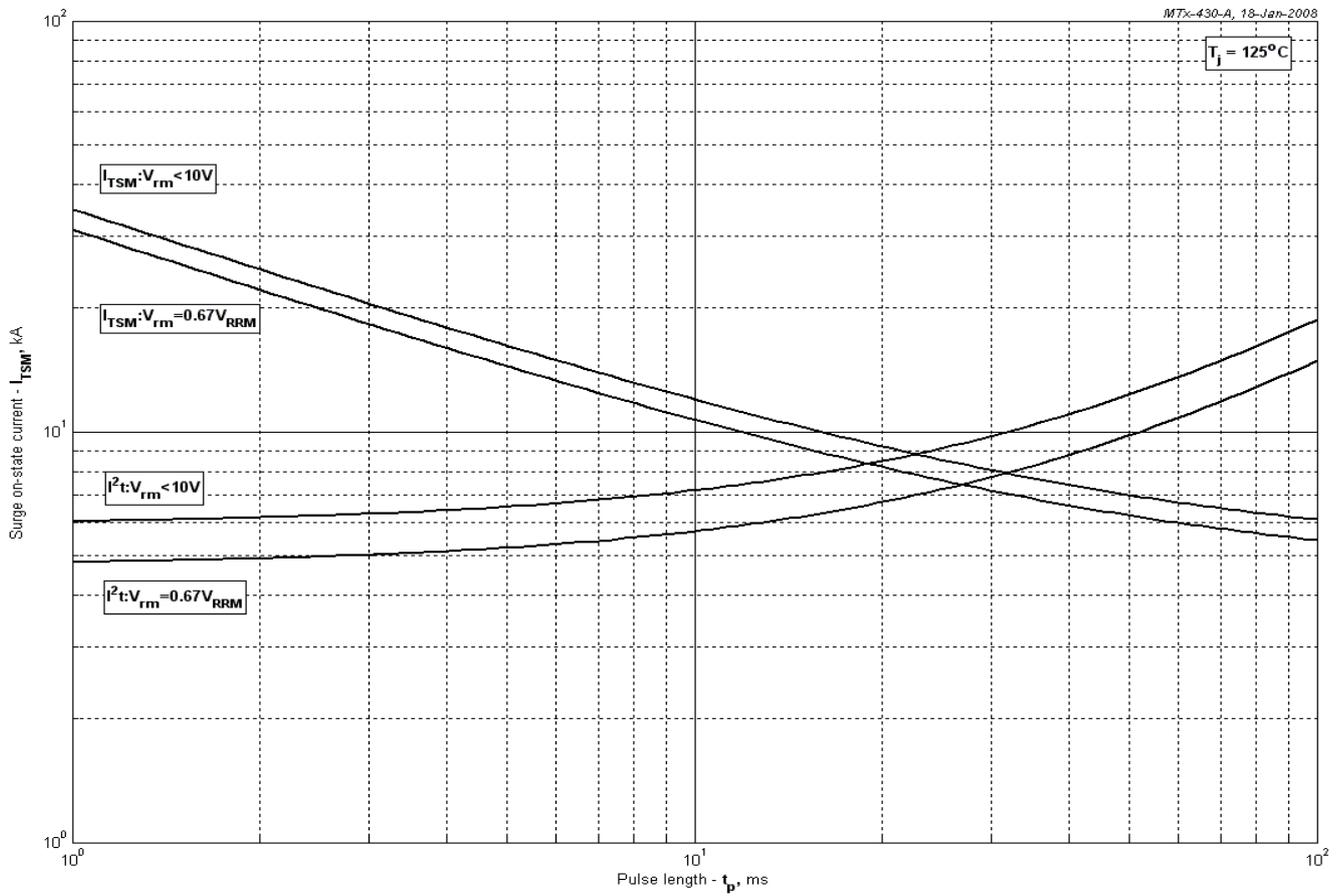


Fig 13 – Maximum surge and I^2t ratings

$T_J = 125^\circ\text{C}$

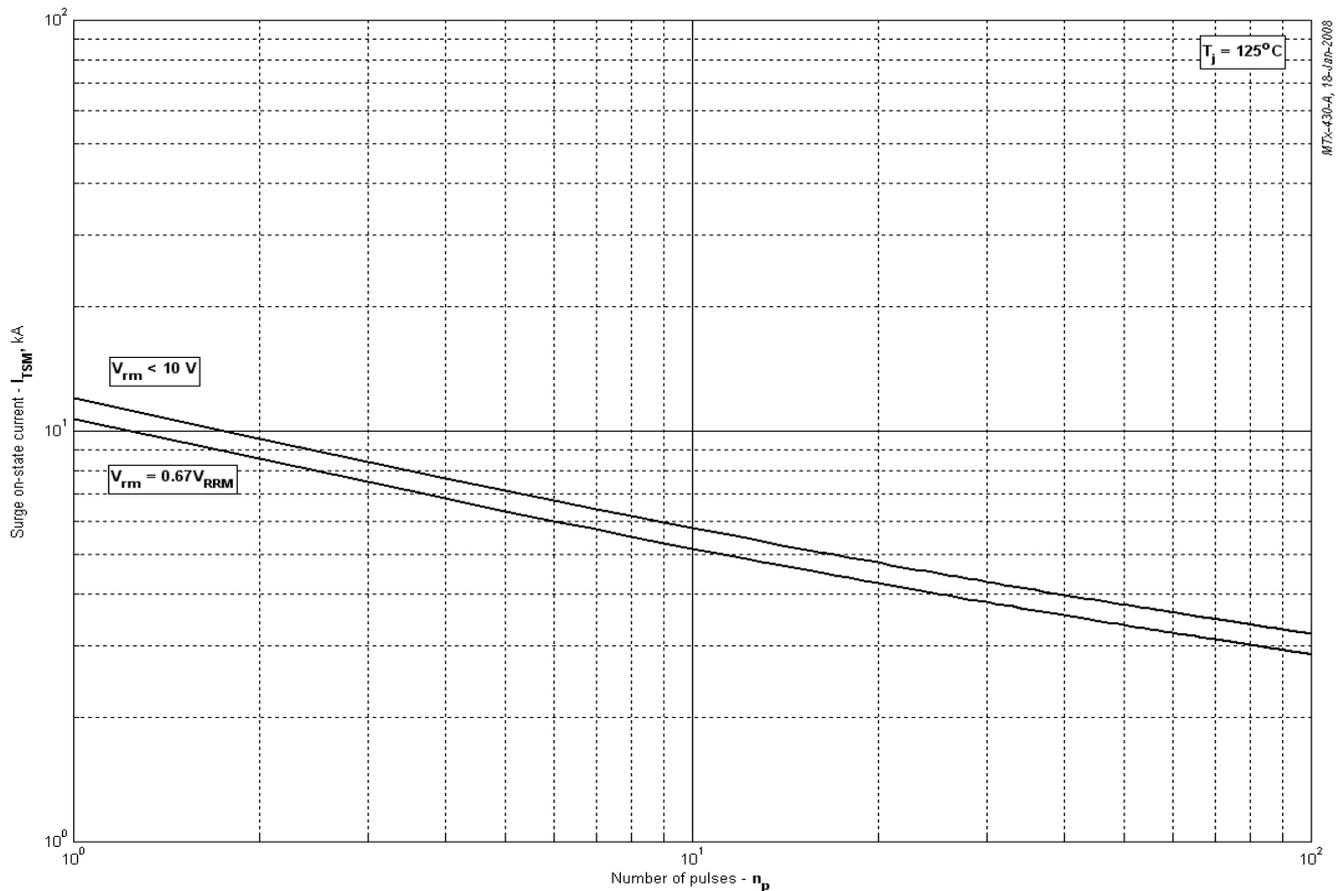


Fig 14 - Maximum surge ratings